Docket No.

ARENT FOX KINTNER PLOTKIN & KAHN, PLLC Nikaido, Marmelstein, Murray & Oram Intellectual Property Group

eclaration For U.S. Patent Application

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below my name.

I believe I am the original first and sole inventor (if only one name is listed be

are listed be	am the original, first and so elow) of the subject matter e) FOAMING AGENT	which is claimed ar	nd for which a patent is s	ought on the invention e		
the specific	ation of which is attached	nereto unless the fol	lowing box is checked:			
_	vas filed on	and	was amended on	PCT International Appl	lication	
and/or w	vas filed on October :	31, 2003		U.S. Patent Appl	lication .	
any amendr I acknowled I hereby cl certificate, of and have al	nent referred to above. Ige the duty to disclose infa aim foreign priority benef or '365(a) of any PCT Into	ormation which is nits under 35 U.S.C ernational application reign application fo	naterial to patentability a: 2. '119(a)-(d) or '365(lon which designated at le r patent or inventor's cell claimed:	s defined in 37 C.F.R. ' b) of any foreign appliant one country other the	cation(s) for patent or inventor's an the United States, listed below ional Application having a filing Priority Claimed	
(List prior	(Number)	(Country)	(Day/Mo	nth/Year Filed)	✓ Yes ☐ No	
application See note A on back of	(Number)	(Country)	(Day/Mor	nth/Year Filed)	∐ Yes ∐ No □ Yes □ No	
this page)	(Number)	(Country)	(Day/Mor	nth/Year Filed)		
I hereby cla	im the benefit under 35 U.	S.C. '119(e) of any	United States provisiona	al application(s) listed be	elow.	
	(Application N	umber)	(Filing Date)			
•	(Application N	umber)	(Filing Date)	1	_	
(See Note I		attached list for add	itional prior foreign or pr	rovisional applications.		
designating disclosed in duty to disc	the United States of Ame the prior application(s) (rica listed below as J.S. or PCT) in the material to patenta	nd, insofar as the subject manner provided by the bility as defined in 37 (et matter of each of the e first paragraph of 35, C.F.R. '1.56 which because	PCT International application(s) claims of this application is not U.S.C. '112, I acknowledge the ame available between the filing	
(List prior U.S. Applications or		rial No.)	(Filing Date)	(Status) (pat	(Status) (patented, pending, abandoned)	
PCT Internation applications designating the	(Application Se	rial No.)	(Filing Date)	(Status) (pat	ented, pending, abandoned)	
And I hereb Oram, Jr., F 36,105; Ric No. 44,275;	by appoint as principal atto Reg. No. 27,931; Douglas hard J. Berman, Reg. No.	H. Goldhush, Reg. 39,107; King L. W . No. 43,637, N. Al	No. 33,125; David T. 1 ong, Reg. No. 37,500; Ja exander Nolte, Reg. No.	Nikaido, Reg. No. 22,66 imes A. Poulos, III, Reg	ein, Reg. No. 25,895; George E. 3; Monica Chin Kitts, Reg. No. 5, No. 31,714; Murat Ozgu, Reg. 1, No. 34,794; Gregory	
Please direc	t all communications to the	following address:	1050 Connecticut Av Washington, D.C. 20	NER PLOTKIN & KAH venue, N.W., Suite 600 1036-5339 857-6000; Facsimile No		
believed to l punishable b	be true; and further, that th	ese statements were both, under Section ication or any paten	e made with the knowled 1 1001 of Title 18 of the	lge that willful false star United States Code and	de on information and belief are tements and the like so made are that such willful false statements	
(See Note C on back of	Full name of sole or fi Inventor's signature		7144		30 Can Jon?	
this page)		iyagi, Japan	LINNDANO			
•	Residence M. Japan	an				
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Full name of sole or fir	st inventor Ka	tsuhiro Shil	oata			
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